

## INFORMATION DISCLOSURE STATEMENT

Applicant	:	Agarwal, et al.
App. No.	:	Unknown
Filed	:	Herewith
For	:	BORON INCORPORATED DIFFUSION BARRIER MATERIAL
Examiner	:	Unknown
Group Art Unit	:	Unknown

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Enclosed is form PTO-1449 listing 34 references. These references are of record in related Applications Serial No. 09/382,295, filed 8/24/99; and Serial No. 09/839,584, filed 4/20/01. Therefore copies of these references are not enclosed.

Applicants also note that this application is related to U.S. Patent Application No. 09/738,592, filed 12/15/00, now U.S. Patent No. 6,511,900, which issued January 28, 2003.

This Information Disclosure Statement is being filed upon filing of this application, therefore, no fee is required in accordance with 37 C.F.R. § 1.97(b)(1).

Respectfully submitted,  
KNOBBE, MARTENS, OLSON & BEAR, LLP

Dated: 10/6/03

By: John R. King  
John R. King  
Registration No. 34,362  
Attorney of Record  
Customer No. 20,995  
(949) 760-0404

FORM PTO-1449	U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	ATTY. DOCKET NO. MICRON.095DV2C1	APPLICATION NO. Unknown
<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b>  (USE SEVERAL SHEETS IF NECESSARY)		APPLICANT Agarwal, et al.	
		FILING DATE Herewith	GROUP

U.S. PATENT DOCUMENTS							
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE (IF APPROPRIATE)
		4,761,386	8/2/88	Buynoski			
		4,823,182	4/18/89	Okumura			
		4,884,123	11/28/89	Dixit, et al.			
		4,895,770	1/23/90	Schintlmeister, et al.			
		4,920,071	4/24/90	Thomas			
		5,225,771	7/6/93	Leedy			
		5,248,903	9/28/93	Heim			
		5,298,333	3/29/94	Maixner, et al.			
		5,364,803	11/15/94	Lur, et al.			
		5,391,516	2/21/95	Wojnarowski, et al.			
		5,441,904	8/15/95	Kim, et al.			
		5,486,492	1/23/96	Yamamoto, et al.			
		5,506,499	4/9/96	Puar			
		5,541,427	7/30/96	Chappell, et al.			
		5,593,903	1/14/97	Beckenbaugh, et al.			
		5,668,394	9/16/97	Lur, et al.			
		5,684,304	11/4/97	Smears			
		5,693,377	12/2/97	Westmoreland, et al.			
		5,720,098	2/24/98	Kister			
		5,742,174	4/21/98	Kister, et al.			
		5,837,598	11/17/98	Aronowitz, et al.			
		5,851,680	12/22/98	Heau			
		5,920,081	7/6/99	Chen, et al.			
		5,962,867	10/5/99	Liu			
		5,968,594	10/19/99	Hu, et al.			
		5,994,716	11/30/99	Ikeya, et al.			
		6,028,360	2/22/00	Nakamura, et al.			

EXAMINER	DATE CONSIDERED
*EXAMINER: INITIAL IF CITATION CONSIDERED, WHETHER OR NOT CITATION IS IN CONFORMANCE WITH MPEP 609; DRAW LINE THROUGH CITATION IF NOT IN CONFORMANCE AND NOT CONSIDERED, INCLUDE COPY OF THIS FORM WITH NEXT COMMUNICATION TO APPLICANT.	

FORM PTO-1449 U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE  <b>INFORMATION DISCLOSURE STATEMENT          BY APPLICANT</b>  (USE SEVERAL SHEETS IF NECESSARY)	ATTY. DOCKET NO. MICRON.095DV2C1	APPLICATION NO. Unknown
	APPLICANT Agarwal, et al.	
	FILING DATE Herewith	GROUP 2823

U.S. PATENT DOCUMENTS							
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE (IF APPROPRIATE)
		6,017,818	1/25/00	Lu			
		6,069,482	5/30/00	Hilton			
		6,133,582	10/17/00	Osann, Jr., et al.			
		6,200,649	3/13/01	Dearnaley			

FOREIGN PATENT DOCUMENTS								
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
		EP 0854 505 A2	7/22/98	Europe				

EXAMINER INITIAL	OTHER DOCUMENTS (INCLUDING AUTHOR, TITLE, DATE, PERTINENT PAGES, ETC.)	
	Baker, et al. "Combined X-Ray Photoelectron/auger Electron Spectroscopy/Glaning Angle X-Ray diffraction/Extended X-Ray Absorbion Fine Structure Investigation of TiBxNy Coatings". J. Vac. Sci. Technol., A 15(2), pp. 284-291, March/April 1997	
	Sade, et al., "Characterization of TiB2/TiSi2 Bilayer Structure Deposited By Sputtering", Mat. Res. Soc. Smp. Proc., Vol. 402, pp. 131-136, 1996	

H:\DOCS\KJL\KJL-2351.DOC  
100103

EXAMINER	DATE CONSIDERED
*EXAMINER: INITIAL IF CITATION CONSIDERED, WHETHER OR NOT CITATION IS IN CONFORMANCE WITH MPEP 609; DRAW LINE THROUGH CITATION IF NOT IN CONFORMANCE AND NOT CONSIDERED, INCLUDE COPY OF THIS FORM WITH NEXT COMMUNICATION TO APPLICANT.	